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Details

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Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	33
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx230f064dt-i-pt

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44

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TABLE 14: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN VTLA (TOP VIEW)^(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	Vdd
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	Vdd
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices.

5: Shaded pins are 5V tolerant.

		Pin Nu	mber ⁽¹⁾								
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description				
USBID	₁₁ (3)	14 ⁽³⁾	15 (3)	41 ⁽³⁾	I	ST	USB OTG ID detect				
CTED1	27	2	33	19	I	ST	CTMU External Edge Input				
CTED2	28	3	34	20	I	ST	7				
CTED3	13	16	17	43	I	ST	7				
CTED4	15	18	19	1	I	ST	7				
CTED5	22	25	28	14	I	ST	7				
CTED6	23	26	29	15	I	ST	7				
CTED7	_	_	20	5	I	ST	7				
CTED8	_		_	13	I	ST	7				
CTED9	9	12	10	34	I	ST	7				
CTED10	14	17	18	44	I	ST	7				
CTED11	18	21	24	8	I	ST	7				
CTED12	2	5	36	22	I	ST	7				
CTED13	3	6	1	23	I	ST	7				
CTPLS	21	24	27	11	0	_	CTMU Pulse Output				
PGED1	1	4	35	21	I/O	ST	Data I/O pin for Programming/Debuggin Communication Channel 1				
PGEC1	2	5	36	22	Ι	ST	Clock input pin for Programming/Debugging Communication Channel 1				
PGED2	18	21	24	8	I/O	ST	Data I/O pin for Programming/Debuggin Communication Channel 2				
PGEC2	19	22	25	9	I	ST	Clock input pin for Programming/Debugging Communication Channel 2				
PGED3	11 ⁽²⁾ 27 ⁽³⁾	14 ⁽²⁾ 2 ⁽³⁾	15 ⁽²⁾ 33 ⁽³⁾	41 ⁽²⁾ 19 ⁽³⁾	I/O	ST	Data I/O pin for Programming/Debuggin Communication Channel 3				
	12 (2)	15 (2)	16 (2)	42 ⁽²⁾		OT	Clock input pin for Programming/				
PGEC3	28 ⁽³⁾	3 (3)	34 ⁽³⁾	20 ⁽³⁾		ST	Debugging Communication Channel 3				
PGED4	—	—	3	12	I/O	ST	Data I/O pin for Programming/Debuggir Communication Channel 4				
PGEC4	—	—	4	13	I	ST	Clock input pin for Programming/ Debugging Communication Channel 4				

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

TTL = TTL input buffer PPS = Peripheral Pin Select

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

3: Pin number for PIC32MX2XX devices only.

— = N/A

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	_	_	—	_	—	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	_	—	_	—	—	—
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
15:8				BMXDU	DBA<15:8>			
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0				BMXDU	DBA<7:0>			

REGISTER 4-3: BMXDUDBA: DATA RAM USER DATA BASE ADDRESS REGISTER

Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 BMXDUDBA<15:10>: DRM User Data Base Address bits

When non-zero, the value selects the relative base address for User mode data space in RAM, the value must be greater than BMXDKPBA.

bit 9-0 BMXDUDBA<9:0>: Read-Only bits This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

6.1 Reset Control Registers

TABLE 6-1: RESET CONTROL REGISTER MAP

ess		0									Bits								s
Virtual Address (BF80_#)	VIrtual Addr (BF80_#) Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Reset
F600	RCON	31:16	_	_	_		—	_		—	_	_		_		-	-	_	0000
1 000	ROOM	15:0	_		-		_	-	CMR	VREGS	EXTR	SWR		WDTO	SLEEP	IDLE	BOR	POR	xxxx(2)
E610	RSWRST	31:16		—	-	—	—	—	—	—		—	—	_	—	_	—	—	0000
1010	N31/K31	15:0	_	_	_	-	_	—		—	_	_	-	_	_	_	-	SWRST	0000

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

2: Reset values are dependent on the DEVCFGx Configuration bits and the type of reset.

TABLE 7-1: INTERRUPT IRQ, VECTOR AND BIT LOCATION

(1)	IRQ	Vector		Interru	pt Bit Location		Persistent				
Interrupt Source ⁽¹⁾	#	#	Flag	Enable	Priority	Sub-priority	Interrupt				
		Highes	st Natural C	Natural Order Priority							
CT – Core Timer Interrupt	0	0	IFS0<0>	IEC0<0>	IPC0<4:2>	IPC0<1:0>	No				
CS0 – Core Software Interrupt 0	1	1	IFS0<1>	IEC0<1>	IPC0<12:10>	IPC0<9:8>	No				
CS1 – Core Software Interrupt 1	2	2	IFS0<2>	IEC0<2>	IPC0<20:18>	IPC0<17:16>	No				
INT0 – External Interrupt	3	3	IFS0<3>	IEC0<3>	IPC0<28:26>	IPC0<25:24>	No				
T1 – Timer1	4	4	IFS0<4>	IEC0<4>	IPC1<4:2>	IPC1<1:0>	No				
IC1E – Input Capture 1 Error	5	5	IFS0<5>	IEC0<5>	IPC1<12:10>	IPC1<9:8>	Yes				
IC1 – Input Capture 1	6	5	IFS0<6>	IEC0<6>	IPC1<12:10>	IPC1<9:8>	Yes				
OC1 – Output Compare 1	7	6	IFS0<7>	IEC0<7>	IPC1<20:18>	IPC1<17:16>	No				
INT1 – External Interrupt 1	8	7	IFS0<8>	IEC0<8>	IPC1<28:26>	IPC1<25:24>	No				
T2 – Timer2	9	8	IFS0<9>	IEC0<9>	IPC2<4:2>	IPC2<1:0>	No				
IC2E – Input Capture 2	10	9	IFS0<10>	IEC0<10>	IPC2<12:10>	IPC2<9:8>	Yes				
IC2 – Input Capture 2	11	9	IFS0<11>	IEC0<11>	IPC2<12:10>	IPC2<9:8>	Yes				
OC2 – Output Compare 2	12	10	IFS0<12>	IEC0<12>	IPC2<20:18>	IPC2<17:16>	No				
INT2 – External Interrupt 2	13	11	IFS0<13>	IEC0<13>	IPC2<28:26>	IPC2<25:24>	No				
T3 – Timer3	14	12	IFS0<14>	IEC0<14>	IPC3<4:2>	IPC3<1:0>	No				
IC3E – Input Capture 3	15	13	IFS0<15>	IEC0<15>	IPC3<12:10>	IPC3<9:8>	Yes				
IC3 – Input Capture 3	16	13	IFS0<16>	IEC0<16>	IPC3<12:10>	IPC3<9:8>	Yes				
OC3 – Output Compare 3	17	14	IFS0<17>	IEC0<17>	IPC3<20:18>	IPC3<17:16>	No				
INT3 – External Interrupt 3	18	15	IFS0<18>	IEC0<18>	IPC3<28:26>	IPC3<25:24>	No				
T4 – Timer4	19	16	IFS0<19>	IEC0<19>	IPC4<4:2>	IPC4<1:0>	No				
IC4E – Input Capture 4 Error	20	17	IFS0<20>	IEC0<20>	IPC4<12:10>	IPC4<9:8>	Yes				
IC4 – Input Capture 4	21	17	IFS0<21>	IEC0<21>	IPC4<12:10>	IPC4<9:8>	Yes				
OC4 – Output Compare 4	22	18	IFS0<22>	IEC0<22>	IPC4<20:18>	IPC4<17:16>	No				
INT4 – External Interrupt 4	23	19	IFS0<23>	IEC0<23>	IPC4<28:26>	IPC4<25:24>	No				
T5 – Timer5	24	20	IFS0<24>	IEC0<24>	IPC5<4:2>	IPC5<1:0>	No				
IC5E – Input Capture 5 Error	25	21	IFS0<25>	IEC0<25>	IPC5<12:10>	IPC5<9:8>	Yes				
IC5 – Input Capture 5	26	21	IFS0<26>	IEC0<26>	IPC5<12:10>	IPC5<9:8>	Yes				
OC5 – Output Compare 5	27	22	IFS0<27>	IEC0<27>	IPC5<20:18>	IPC5<17:16>	No				
AD1 – ADC1 Convert done	28	23	IFS0<28>	IEC0<28>	IPC5<28:26>	IPC5<25:24>	Yes				
FSCM – Fail-Safe Clock Monitor	29	24	IFS0<29>	IEC0<29>	IPC6<4:2>	IPC6<1:0>	No				
RTCC – Real-Time Clock and Calendar	30	25	IFS0<30>	IEC0<30>	IPC6<12:10>	IPC6<9:8>	No				
FCE – Flash Control Event	31	26	IFS0<31>	IEC0<31>	IPC6<20:18>	IPC6<17:16>	No				
CMP1 – Comparator Interrupt	32	27	IFS1<0>	IEC1<0>	IPC6<28:26>	IPC6<25:24>	No				
CMP2 – Comparator Interrupt	33	28	IFS1<1>	IEC1<1>	IPC7<4:2>	IPC7<1:0>	No				
CMP3 – Comparator Interrupt	34	29	IFS1<2>	IEC1<2>	IPC7<12:10>	IPC7<9:8>	No				
USB – USB Interrupts	35	30	IFS1<3>	IEC1<3>	IPC7<20:18>	IPC7<17:16>	Yes				
SPI1E – SPI1 Fault	36	31	IFS1<4>	IEC1<4>	IPC7<28:26>	IPC7<25:24>	Yes				
SPI1RX – SPI1 Receive Done	37	31	IFS1<5>	IEC1<5>	IPC7<28:26>	IPC7<25:24>	Yes				
SPI1TX – SPI1 Transfer Done	38	31	IFS1<6>	IEC1<6>	IPC7<28:26>	IPC7<25:24>	Yes				

Note 1: Not all interrupt sources are available on all devices. See TABLE 1: "PIC32MX1XX 28/36/44-Pin General Purpose Family Features" and TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" for the lists of available peripherals.

ILCIOIC L													
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
31:24	—	—	_	—	_	—	_	_					
22:16	U-0	U-0 U-0		U-0	U-0	U-0	U-0	U-0					
23:16		_		_	_		_						
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
15:8	CHCSIZ<15:8>												
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0				CHCSIZ	<7:0>								

REGISTER 9-16: DCHxCSIZ: DMA CHANNEL 'x' CELL-SIZE REGISTER

Legend:R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHCSIZ<15:0>: Channel Cell Size bits

1111111111111111 = 65,535 bytes transferred on an event

REGISTER 9-17: DCHxCPTR: DMA CHANNEL 'x' CELL POINTER REGISTER

			•••••••••••				-	
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	—	—	—	_	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	—	—	—	—	—
45.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
15:8				CHCPTR	<15:8>			
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0				CHCPTF	R<7:0>			

Legend:								
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'						
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					

bit 31-16 Unimplemented: Read as '0'

Note: When in Pattern Detect mode, this register is reset on a pattern detect.

13.0 TIMER2/3, TIMER4/5

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 14. "Timers"** (DS60001105), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

This family of PIC32 devices features four synchronous 16-bit timers (default) that can operate as a freerunning interval timer for various timing applications and counting external events. The following modes are supported:

- Synchronous internal 16-bit timer
- Synchronous internal 16-bit gated timer
- · Synchronous external 16-bit timer

Two 32-bit synchronous timers are available by combining Timer2 with Timer3 and Timer4 with Timer5. The 32-bit timers can operate in three modes:

- Synchronous internal 32-bit timer
- · Synchronous internal 32-bit gated timer
- Synchronous external 32-bit timer

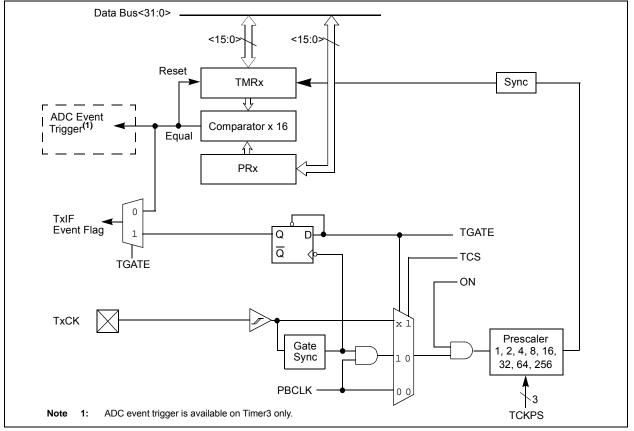
Note:	In this chapter, references to registers,
	TxCON, TMRx and PRx, use 'x' to
	represent Timer2 through Timer5 in 16-bit
	modes. In 32-bit modes, 'x' represents
	Timer2 or Timer4 and 'y' represents
	Timer3 or Timer5.

13.1 Additional Supported Features

- · Selectable clock prescaler
- Timers operational during CPU idle
- Time base for Input Capture and Output Compare modules (Timer2 and Timer3 only)
- ADC event trigger (Timer3 in 16-bit mode, Timer2/3 in 32-bit mode)
- Fast bit manipulation using CLR, SET and INV registers

Figure 13-1 and Figure 13-2 illustrate block diagrams of Timer2/3 and Timer4/5.

FIGURE 13-1: TIMER2-TIMER5 BLOCK DIAGRAM (16-BIT)



17.1 SPI Control Registers

TABLE 17-1: SPI1 AND SPI2 REGISTER MAP

ess		Ċ,								Bi	ts								
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
5800	SPI1CON	31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FF	RMCNT<2:()>	MCLKSEL	—	_	-	—	_	SPIFE	ENHBUF	0000
3800	SFILCON	15:0	ON	_	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI	STXISE	L<1:0>	SRXISE	EL<1:0>	0000
5910	SPI1STAT	STAT 31:16 TXBUFELM<4:0> TXBUFELM<4:0>								0000									
5610		15:0	_	—	—	FRMERR	SPIBUSY	—	—	SPITUR	SRMT	SPIROV	SPIRBE	—	SPITBE	—	SPITBF	SPIRBF	0008
5820	SPI1BUF	31:16	DATA<31:0>								0000								
3020		15:0		00									0000						
5830	SPI1BRG	31:16	—	—	_	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
0000		15:0											0000						
		31:16	—	—	—	—	—	—	—	—	—	—	_	_	—	_	—	—	0000
5840	SPI1CON2	15:0	SPI SGNEXT	_		FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	—	-	-	AUD MONO	_	AUDMC)D<1:0>	0000
5400	SPI2CON	31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FF	RMCNT<2:()>	MCLKSEL	—			_		SPIFE	ENHBUF	0000
5A00	3F1200N	15:0	ON	_	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI	STXISE	L<1:0>	SRXISE	EL<1:0>	0000
5410	SPI2STAT	31:16	—	_			RXE	BUFELM<4:	0>		_	-			TX	BUFELM<4	:0>		0000
SATU	3F1231AI	15:0	_	_	_	FRMERR	SPIBUSY	_	_	SPITUR	SRMT	SPIROV	SPIRBE	_	SPITBE	_	SPITBF	SPIRBF	0008
5A20	SPI2BUF	31:16								DATA<	31.0>								0000
5420		15:0	000									0000							
5A30	SPI2BRG	31:16	—	—	_	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
5730		15:0		—	—						E	3RG<12:0>							0000
		31:16	—	—	—	_	—	_	—	—	—	—	_	—	—	—	—	—	0000
5A40	SPI2CON2	15:0	SPI SGNEXT	—	_	FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	—	_	_	AUD MONO	_	AUDMC)D<1:0>	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

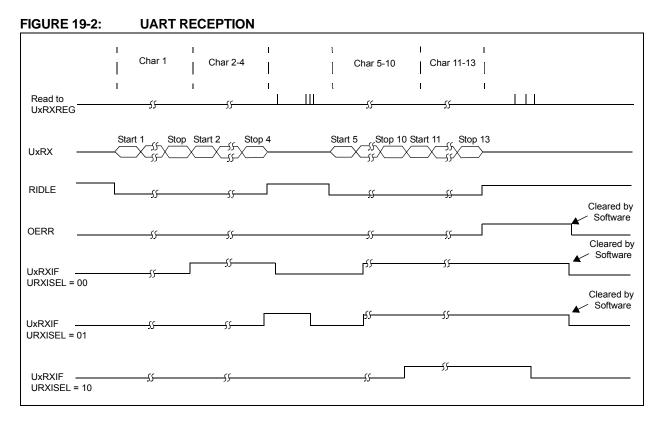
Note 1: All registers in this table except SPIxBUF have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

REGISTER 19-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

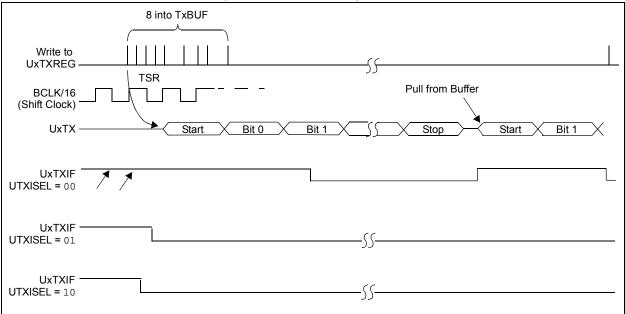
bit 5	 ABAUD: Auto-Baud Enable bit 1 = Enable baud rate measurement on the next character – requires reception of Sync character (0x55); cleared by hardware upon completion 0 = Baud rate measurement disabled or completed
bit 4	RXINV: Receive Polarity Inversion bit 1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH: High Baud Rate Enable bit 1 = High-Speed mode – 4x baud clock enabled 0 = Standard Speed mode – 16x baud clock enabled
bit 2-1	PDSEL<1:0>: Parity and Data Selection bits 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL: Stop Selection bit 1 = 2 Stop bits 0 = 1 Stop bit

Note 1: When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

Figure 19-2 and Figure 19-3 illustrate typical receive and transmit timing for the UART module.







Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
31:24	CH0NB	_	_	_		CH0SB	<3:0>		
00.40	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	CH0NA		_	_	CH0SA<3:0>				
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
15:8	_	_	_	_	_		_	-	
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	

REGISTER 22-4: AD1CHS: ADC INPUT SELECT REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31		CH0NB: Negative Input Select bit for Sample B
		1 = Channel 0 negative input is AN1
		0 = Channel 0 negative input is VREFL
bit 30	-28	Unimplemented: Read as '0'
bit 27	-24	CH0SB<3:0>: Positive Input Select bits for Sample B
		1111 = Channel 0 positive input is Open ⁽¹⁾
		1110 = Channel 0 positive input is IVREF ⁽²⁾
		1101 = Channel 0 positive input is CTMU temperature sensor (CTMUT) ⁽³⁾
		1100 = Channel 0 positive input is AN12 ⁽⁴⁾
		•
		•
		•
		0001 = Channel 0 positive input is AN1
		0000 = Channel 0 positive input is AN0
bit 23		CH0NA: Negative Input Select bit for Sample A Multiplexer Setting ⁽²⁾
		1 = Channel 0 negative input is AN1
	~ ~	0 = Channel 0 negative input is VREFL
bit 22	-20	Unimplemented: Read as '0'
bit 19	-16	CH0SA<3:0>: Positive Input Select bits for Sample A Multiplexer Setting
		1111 = Channel 0 positive input is Open ⁽¹⁾
		1110 = Channel 0 positive input is IVREF ⁽²⁾
		1101 = Channel 0 positive input is CTMU temperature (CTMUT) ⁽³⁾ 1100 = Channel 0 positive input is AN12 ⁽⁴⁾
		- Channel O positive input in AN1
		0001 = Channel 0 positive input is AN1 0000 = Channel 0 positive input is AN0
bit 15	0	Unimplemented: Read as '0'
bit 15	-0	Ommplemented. Nead as 0
Note	1:	This selection is only used with CTMU capacitive and time measurement.
	2:	See Section 24.0 "Comparator Voltage Reference (CVREF)" for more information.
	3:	See Section 25.0 "Charge Time Measurement Unit (CTMU)" for more information.
	3. 4:	AN12 is only available on 44-pin devices. AN6-AN8 are not available on 28-pin devices.
	т.	

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	_		—	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	_	—	—	—	_
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	CSSL15	CSSL14	CSSL13	CSSL12	CSSL11	CSSL10	CSSL9	CSSL8
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	CSSL7	CSSL6	CSSL5	CSSL4	CSSL3	CSSL2	CSSL1	CSSL0

REGISTER 22-5: AD1CSSL: ADC INPUT SCAN SELECT REGISTER

Legend:

Logena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CSSL<15:0>: ADC Input Pin Scan Selection bits^(1,2)

1 = Select ANx for input scan

0 = Skip ANx for input scan

- **Note 1:** CSSL = ANx, where 'x' = 0-12; CSSL13 selects CTMU input for scan; CSSL14 selects IVREF for scan; CSSL15 selects Vss for scan.
 - 2: On devices with less than 13 analog inputs, all CSSLx bits can be selected; however, inputs selected for scan without a corresponding input on the device will convert to VREFL.

NOTES:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
31:24	—			-	_		_	-
00.40	r-1	r-1	r-1	r-1	r-1	R/P	R/P	R/P
23:16	—	_	—	-	—	FPLLODIV<2:0>		
45.0	R/P	r-1	r-1	r-1	r-1	R/P	R/P	R/P
15:8	UPLLEN ⁽¹⁾		—	_	_	UF	PLLIDIV<2:0>	.(1)
7:0	r-1	R/P-1	R/P	R/P-1	r-1	R/P	R/P	R/P
	—	FPLLMUL<2:0>			_	F	PLLIDIV<2:0	>

DEVCFG2: DEVICE CONFIGURATION WORD 2 REGISTER 27-3:

Legend:	r = Reserved bit	P = Programmable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31-19 Reserved: Write '1'

bit 15

bit 7

bit 18-16 FPLLODIV<2:0>: Default PLL Output Divisor bits

- 111 = PLL output divided by 256 110 = PLL output divided by 64 101 = PLL output divided by 32 100 = PLL output divided by 16 011 = PLL output divided by 8 010 = PLL output divided by 4 001 = PLL output divided by 2 000 = PLL output divided by 1 UPLLEN: USB PLL Enable bit⁽¹⁾ 1 = Disable and bypass USB PLL 0 = Enable USB PLL bit 14-11 Reserved: Write '1' bit 10-8 UPLLIDIV<2:0>: USB PLL Input Divider bits⁽¹⁾ 111 = 12x divider 110 = 10x divider 101 = 6x divider100 = 5x divider 011 = 4x divider 010 = 3x divider 010 = 3x divider 001 = 2x divider000 = 1x divider Reserved: Write '1'
- bit 6-4 FPLLMUL<2:0>: PLL Multiplier bits
 - 111 = 24x multiplier 110 = 21x multiplier
 - 101 = 20x multiplier
 - 100 = 19x multiplier
 - 011 = 18x multiplier
 - 010 = 17x multiplier
 - 001 = 16x multiplier
 - 000 = 15x multiplier
- bit 3 Reserved: Write '1'

Note 1: This bit is only available on PIC32MX2XX devices.

29.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

29.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent[®] and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika[®]

30.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MX1XX/2XX 28/36/44-pin Family electrical characteristics for devices that operate at 40 MHz. Refer to **Section 31.0** "**50 MHz Electrical Characteristics**" for additional specifications for operations at higher frequency. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MX1XX/2XX 28/36/44-pin Family devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias	40°C to +105°C
Storage temperature	
Voltage on VDD with respect to Vss	
Voltage on any pin that is not 5V tolerant, with respect to Vss (Note 3)	0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when VDD $\ge 2.3V$ (Note 3)	0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to Vss when VDD < 2.3V (Note 3)	0.3V to +3.6V
Voltage on D+ or D- pin with respect to VUSB3V3	0.3V to (VUSB3V3 + 0.3V)
Voltage on VBUS with respect to VSS	0.3V to +5.5V
Maximum current out of Vss pin(s)	
Maximum current into VDD pin(s) (Note 2)	
Maximum output current sunk by any I/O pin	15 mA
Maximum output current sourced by any I/O pin	15 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports (Note 2)	200 mA

Note 1: Stresses above those listed under "**Absolute Maximum Ratings**" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).

3: See the "Pin Diagrams" section for the 5V tolerant pins.

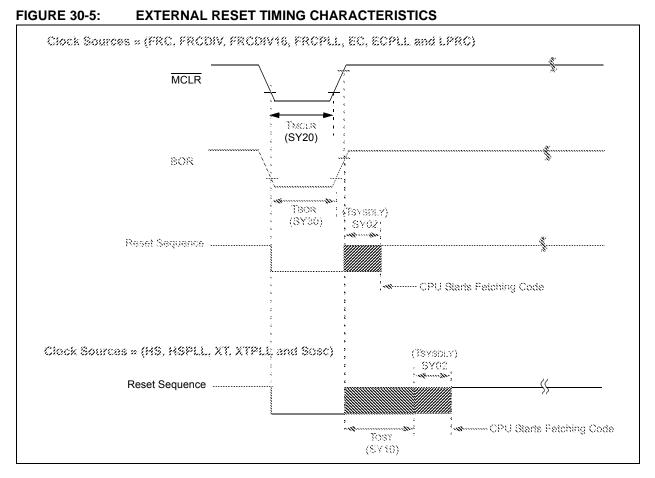


TABLE	TABLE 30-22: RESETS TIMING							
AC CHARACTERISTICS				Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industria $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions	
SY00	Τρυ	Power-up Period Internal Voltage Regulator Enabled	—	400	600	μS	_	
SY02	TSYSDLY	System Delay Period: Time Required to Reload Device Configuration Fuses plus SYSCLK Delay before First instruction is Fetched.	_	1 μs + 8 SYSCLK cycles	_	_	_	
SY20	TMCLR	MCLR Pulse Width (low)	2	_	_	μS	—	
SY30	TBOR	BOR Pulse Width (low)		1	_	μS	—	

These parameters are characterized, but not tested in manufacturing. Note 1:

2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Characterized by design but not tested.

TABLE 30-34: ADC MODULE SPECIFICATIONS

	AC CHAR	ACTERISTICS	(unless otl	herwise stat	ed) -40°C ≤ TA	√≤ +85°	e 5): 2.5V to 3.6V C for Industrial °C for V-temp
Param. No.	Symbol	Characteristics	Min. Typical Ma			Units	Conditions
ADC Ac	curacy – N	leasurements with Inter	nal VREF+/V	REF-			•
AD20d	Nr	Resolution		10 data bits	3	bits	(Note 3)
AD21d	INL	Integral Non-linearity	> -1	_	< 1	LSb	VINL = AVSS = 0V, AVDD = 2.5V to 3.6V (Note 3)
AD22d	DNL	Differential Non-linearity	> -1	—	< 1	LSb	VINL = AVss = 0V, AVDD = 2.5V to 3.6V (Notes 2,3)
AD23d	Gerr	Gain Error	> -4	_	< 4	LSb	VINL = AVSS = 0V, AVDD = 2.5V to 3.6V (Note 3)
AD24d	EOFF	Offset Error	> -2	_	< 2	Lsb	VINL = AVSS = 0V, AVDD = 2.5V to 3.6V (Note 3)
AD25d		Monotonicity			_	_	Guaranteed
Dynami	c Performa	ance	·				<u> </u>
AD32b	SINAD	Signal to Noise and Distortion	55	58.5	_	dB	(Notes 3,4)
AD34b	ENOB	Effective Number of bits	9.0	9.5		bits	(Notes 3,4)

Note 1: These parameters are not characterized or tested in manufacturing.

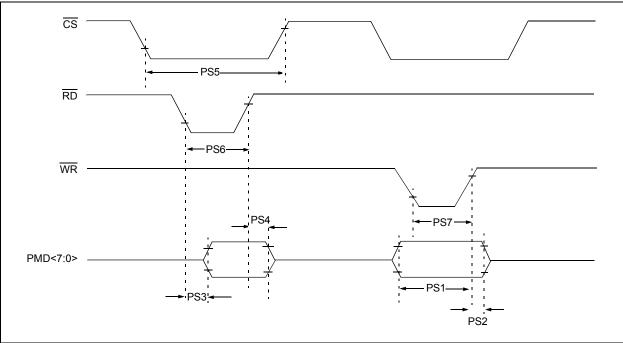
2: With no missing codes.

3: These parameters are characterized, but not tested in manufacturing.

4: Characterized with a 1 kHz sine wave.

5: The ADC module is functional at VBORMIN < VDD < 2.5V, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

FIGURE 30-20: PARALLEL SLAVE PORT TIMING



PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

Program Memory Size Pin Count Software Targeting Tape and Reel Flag (if Speed (if applicable) Temperature Range Package	32-bit RISC MCU with M4K [®] core, 32 KB program memory, 44-pin,
	Flash Memory Family
Architecture	$MX = M4K^{\odot} MCU \text{ core}$
Product Groups	1XX = General purpose microcontroller family 2XX = General purpose microcontroller family
Flash Memory Family	F = Flash program memory
Program Memory Size	016 = 16K 032 = 32K 064 = 64K 128 = 128K 256 = 256K
Pin Count	B = 28-pin C = 36-pin D = 44-pin
Software Targeting	B = Targeted for Bluetooth [®] Audio Break-in devices
Speed	 = 40 MHz - () indicates a blank field; package markings for 40 MHz devices do not include the Speed = 50 MHz
Temperature Range	I = -40° C to $+85^{\circ}$ C (Industrial) V = -40° C to $+105^{\circ}$ C (V-temp)
Package	ML= 28-Lead (6x6 mm) QFN (Plastic Quad Flatpack)ML= 44-Lead (8x8 mm) QFN (Plastic Quad Flatpack)PT= 44-Lead (10x10x1 mm) TQFP (Plastic Thin Quad Flatpack)SO= 28-Lead (7.50 mm) SOIC (Plastic Small Outline)SP= 28-Lead (300 mil) SPDIP (Skinny Plastic Dual In-line)SS= 28-Lead (5.30 mm) SSOP (Plastic Shrink Small Outline)TL= 36-Lead (5x5 mm) VTLA (Very Thin Leadless Array)TL= 44-Lead (6x6 mm) VTLA (Very Thin Leadless Array)
Pattern	Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES = Engineering Sample